

PWM-Embedded 3x4-Channel Constant-Current Sink Driver for LED Strips

Features

- 3x4-channel constant-current sink driver for LED strips
- Constant current range: 3~45mA
- 3 groups of output current, each group is set by an external resistor
- Sustaining voltage at output channels: 17V (max.)
- Supply voltage 3V~5.5V
- Embedded 16-bit PWM generator
 - Gray scale clock generated by the embedded oscillator
 - S-PWM patented technology
- Two selectable modes to trade off between image quality and transmission bandwidth
 - 16-bit gray scale mode
 - 10-bit gray scale mode
- Reliable data transmission
 - Daisy-chain topology
 - Two-wire transmission interface
 - Phase-inversed output clock
 - Built-in buffer for long distance transmission
- Auto-synchronization PWM reset modes
- Selectable polarity reversion to drive high-power drivers or MOSFET
- RoHS-compliant packages

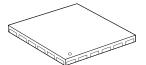
Application

- LED strips
- Mesh display
- Architectural lighting

Shrink SOP

GP: SSOP24L-150-0.64

Quad Flat No-Lead



GFN: QFN24L-4*4-0.5

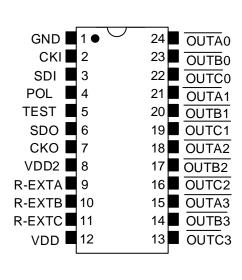
Product Description

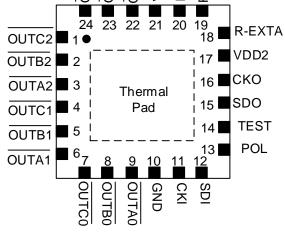
MBI6023 is a 3x4-channel, constant-current, PWM-embedded sink driver for LED strips. MBI6023 provides constant current ranging from 3mA to 45mA for each output channel and are adjustable with three corresponding external resistors. Besides, MBI6023 can support both 3.3V and 5V power systems and sustain 17V at output channels.

With Scrambled-PWM (S-PWM) technology, MBI6023 enhances pulse width modulation by scrambling the "on" time into several "on" periods to increase visual refresh rate at the same gray scale performance. Besides, the gray scale clock (GCLK) is generated by the embedded oscillator. Moreover, MBI6023 provides two selectable gray scale modes to trade off between image quality and transmission: 16-bit gray scale mode and 10-bit gray scale mode.

In addition, MBI6023 features a two-wire transmission interface to make cluster-to-cluster connection easier. To improve the transmission quality, MBI6023 provides phase-inverse output clock to eliminate the accumulation of signal pulse width distortion. In addition, MBI6023 preserves selectable polarity reversion to drive high-power drivers or MOSFET as a PWM controller.

Pin Configuration





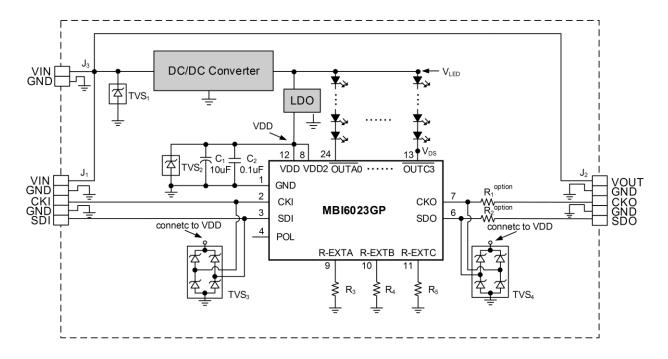
MBI6023GP Top View MBI6023GFN Top View

Terminal Description

Pin		N1	Description and function		
GP	GFN	Name	Description and function		
1	10	GND	Ground terminal		
2	11	СКІ	Input terminal for clock input		
3	12	SDI	Input terminal for serial data input		
4	13	POL	Input terminal for selecting output polarity Internal pull-high High: drive LED or low-active regulators or PMOS Low: output reversed to work as a PWM controller to drive high-active regulators or NMOS		
5	14	TEST	Test pin (Default: internally pulled- low)		
6	15	SDO	Output terminal for serial data output		
7	16	СКО	Output terminal for clock output		
8	17	VDD2	Externally connect to VDD 3.3V/5V supply voltage terminal		
9,10,11	18,19,20	R-EXTA, B, C	Input terminals for setting output current by connecting to an external resistor		
12	21	VDD	3.3V/5V supply voltage terminal		
15,14,13	24,23,22	OUTA3, B3, C3	Output terminals for constant-current output		
18,17,16	3,2,1	OUTA2, B2, C2	Output terminals for constant-current output		
21,20,19	6,5,4	OUTA1, B1, C1	Output terminals for constant-current output		
24,23,22	9,8,7	OUTA0, B0, C0	Output terminals for constant-current output		
-	-	Thermal Pad	Heat dissipation pad* Please connect to GND.		

^{*}The desired thermal conductivity will be improved on condition that a heat-conducting copper foil on PCB is soldered with thermal pad.

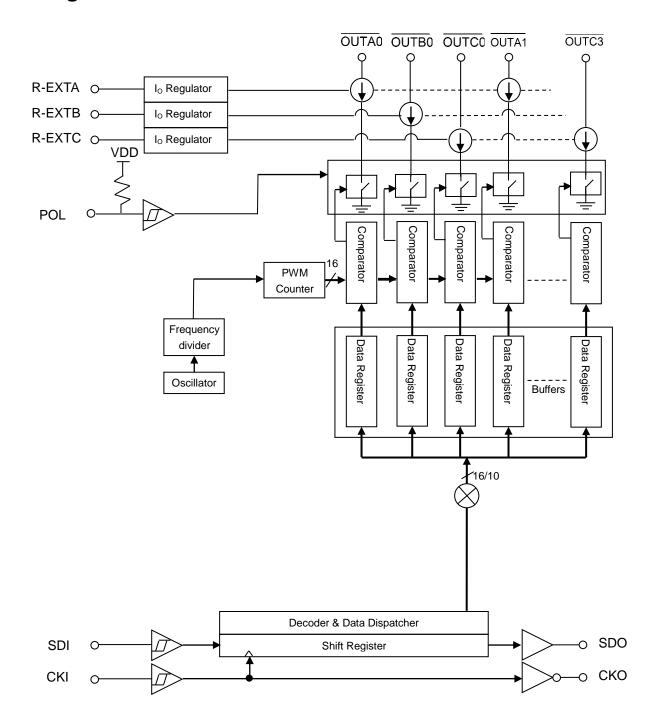
Typical Application Circuit



Note:

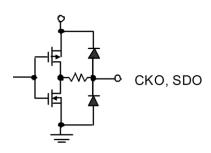
- 1. TVS₁~TVS₄ are Transient Voltage Suppressor (TVS).
- 2. $C_1 \sim C_2$ are required. The values of the $C_1 \sim C_2$ are reference only. Tantalum capacitors and Ceramic capacitors are recommended.
- 3. For hot plug, system grounding, connector design, and other detailed circuit information, please refer to the "MBI6023 Application Note" for detailed information.

Block Diagram

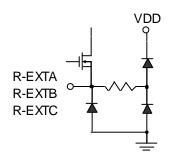


Equivalent Circuits of Inputs and Outputs

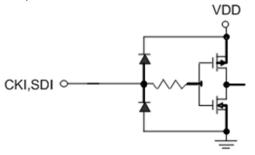
CKO, SDO terminal



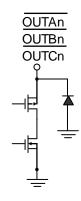
R-EXTA, B, C terminal



CKI, SDI terminal



OUTAn,Bn,Cn terminal



Maximum Ratings

Characteris	tic	Symbol	Rating	Unit
Supply Voltage		V_{DD}	0~7	V
Sustaining Voltage at CKI, SDI Pins	3	V _{IN}	-0.4~V _{DD} +0.4	V
Sustaining Voltage at CKO, SDO P	ns	V _{OUT}	-0.4~V _{DD} +0.4	V
Sustaining Voltage at OUTn Pins		V _{DS}	-0.5~+17	V
Output Current per Output Channel		I _{OUT}	+45	mA
GND Terminal Current		I _{GND}	570	mA
Heat dissipation	GP	P _D	1.76	W
(On 4-Layer PCB, Ta=25°C)*	GFN	P _D	3.19	W
Thermal Resistance	GP	R _{th(j-a)}	70.90	°C/W
(By simulation, on 4-Layer PCB)*	GFN	R _{th(j-a)}	39.15	°C/W
Junction Temperature		$T_{j,max}$	150**	°C
Operating Ambient Temperature		T _{opr}	-40~+85	°C
Storage Temperature		T _{stg}	-55~+150	°C
500 D .:	Human Body Mode (MIL-STD-883H Method 3015.8)	НВМ	Class 3A (5KV)	-
ESD Rating	Machine Mode (ANSI/ESD S5.2-2009 ,)	MM	Class M4 (400V)	-

^{*}The PCB size is 76.2mm*114.3mm in simulation. Please refer to JEDEC JESD51.

Note: The performance of thermal dissipation is strongly related to the size of thermal pad, thickness and layer numbers of the PCB. The empirical thermal resistance may be different from simulative value. Users should plan for expected thermal dissipation performance by selecting package and arranging layout of the PCB to maximize the capability.

^{**}Operation at the maximum rating for extended periods may reduce the device reliability; therefore, the suggested junction temperature of the device is under 125°C.

Electrical Characteristics (V_{DD}=5.0V, Ta=25°C)

Characteris	stics	Symbol	Condition		Min.	Тур.	Max.	Unit
Supply Voltage		V_{DD}	-		4.5	5.0	5.5	V
Sustaining Voltage Ports	at OUT	V _{DS}	OUTAn~OUTCn=Off		-	-	17.0	V
Output Current		I _{OUT}	Refer to "Test C Electrical Chara		5	-	45	mA
Driving Current		I _{OH}	CKO, SDO at V	_{OH} =4.8V	1.8	2.2	2.5	mA
Driving Current		I _{OL}	CKO, SDO at V	_{OH} =0.2V	2.0	2.3	2.8	mΑ
Output Leakage Cu	ırrent	I _{OUT}	V _{DS} =17.0V, OU	JTAn~OUTCn	-	-	1.0	μΑ
Current Skew (Cha	nnel)	dl _{OUT}	I _{OUT} =20mA V _{DS} =1.0V	R _{ext} =7.3KΩ	-	±1.5	±3.0	%
Current Skew (IC)		dl _{OUT2}	I _{OUT} =20mA V _{DS} =1.0V	R _{ext} =7.3KΩ	-	±3.0	±6.0	%
Output Current vs. Output Voltage Reg	gulation*	%/dV _{DS}	V _{DS} within 1.0V and 3.0V,		-	±0.1	±0.5	%/V
Output Current vs. Supply Voltage Regulation*		%/dV _{DD}	V _{DD} within 4.5V and 5.5V		-	±1.0	±2.0	%/V
Input Voltage of	"H" level	V _{IH}	-		$0.73 \times V_{DD}$	-	V_{DD}	V
CKI, SDI Pins	"L" level	V _{IL}	-		GND	-	0.28 x V _{DD}	V
Output Voltage of	"H" level	V _{OL}	I _{OL} =+3.0mA		-	-	0.2	V
CKO, SDO Pins	"L" level	V _{OH}	I _{OH} =-3.0mA		V _{DD} -0.2	-	-	V
Voltage at R-EXTA	,B,C Pins	V_{REXT}	OUTAn~OUTCn=On		1.1	1.22	1.32	V
Knee Voltage*		V _{Knee}	I_{OUT} =45mA for R_{ext} =3.3K Ω		0.7	0.75	0.8	V
	"Off"	I _{DD} (off)	R_{ext} =3.6k Ω , CKI CKO, SDO=NC OUTCn=Off	· ·	6.5	7.5	8.5	
Supply Current**			R _{ext} =7.3KΩ, CK CKO, SDO=NC OUTCn=On	·	4.8	5.5	6.5	mA
	"On" I _{DD} (on)	I _{DD} (on)	R _{ext} =7.3KΩ, CK CKO, SDO=NC OUTCn=On		-	9	10	

^{*}One channel turns on.

^{**}The supply current may vary with the loading conditions.

Electrical Characteristics (V_{DD}=3.3V, Ta=25°C)

Characteris	stics	Symbol	Cond	ition	Min.	Тур.	Max.	Unit
Supply Voltage		V _{DD}	-		3.0	3.3	3.6	V
Sustaining Voltage Ports	at OUT	V _{DS}	OUTAn~OUTCn=Off		-	-	17.0	V
Output Current		I _{OUT}	Refer to "Test Ci Electrical Charac		3	-	30	mA
Driving Current		I _{OH}	CKO, SDO at Vo	_{DH} =3.1V	1.6	1.9	2.4	mΑ
Driving Current		I _{OL}	CKO, SDO at Vo	_{DH} =0.2V	1.6	2.1	2.5	mA
Output Leakage Cu	urrent	I _{OUT}	V _{DS} =17.0V, OU =Off	TAn~OUTCn	-	-	1.0	μΑ
Current Skew (Cha	innel)	dl _{OUT}	I _{OUT} =20mA V _{DS} =1.0V	R _{ext} =7.3KΩ	-	±1.5	±3.0	%
Current Skew (IC)		dl _{OUT2}	I_{OUT} =20mA V_{DS} =1.0V	R _{ext} =7.3KΩ	-	±3.0	±6.0	%
Output Current vs. Output Voltage Regulation*		%/dV _{DS}	V _{DS} within 1.0V and 3.0V		-	±0.1	±0.5	%/V
Output Current vs. Supply Voltage Regulation*		%/dV _{DD}	V _{DD} within 3.0V and 3.6V		-	±1.0	±2.0	%/V
Input Voltage of	"H" level	V _{IH}	-		$0.73 \times V_{DD}$	-	V_{DD}	V
CKI, SDI Pins	"L" level	V _{IL}	-		GND	-	0.28 x V _{DD}	V
Output Voltage of	"H" level	V _{OL}	I _{OL} =+2.0mA		-	-	0.2	V
CKO, SDO Pins	"L" level	V _{OH}	I _{OH} =-2.0mA		V _{DD} -0.2	-	-	V
Voltage at R-EXTA	,B,C Pins	V_{REXT}	OUTAn~OUTCn=On		1.1	1.22	1.32	V
Knee Voltage*		V _{Knee}	I_{OUT} =30mA for R_{ext} =4.88K Ω		0.80	0.82	0.84	V
	"Off"	I _{DD} (off)	R _{ext} =4.88KΩ, CKI,SDI=Low, CKO, SDO= NC, OUTAn~ OUTCn=Off		-	6.5	7.5	
Supply Current**	urrent** "On" I _{DD} (on)		R_{ext} =7.3K Ω , CKI CKO, SDO=NC, OUTCn=On	·	-	5.5	6.5	mA
		I _{DD} (on)	R _{ext} =7.3KΩ, CKI CKO, SDO=NC, OUTCn=On		-	6.5	7.5	

^{*}One channel turns on.

^{**}The supply current may vary with the loading conditions.

Switching Characteristics (V_{DD}=5.0V, Ta=25°C)

	Characteristics	Symbol	Condition	Min.	Тур.	Max.	Unit
Setup Time	SDI-CKI↓	t _{SU}		7.5	-	-	ns
Hold Time	CKI↓-SDI	t _{HD}		7.5	-	-	ns
	CKI↑–CKO↓	t _{PHL1}		-	49	-	ns
	CKI↓-SDO↑↓	t _{PHL2}		-	44	-	ns
Propagation	GCLK↑- OUTBO, OUTA1, OUTB2↓	t _{PHL3}		22	30	38	ns
Delay Time ("H" to "L")	GCLK↑- OUTC1, OUTA3, OUTC3↓	t _{PHL4}		27	35	43	ns
	GCLK↑- OUTAO , OUTCO , OUTA2 ↓	t _{PHL5}	$V_{LED}=4V$	32	40	48	ns
	GCLK↑– OUTB1 , OUTC2 , OUTB3 ↓	t _{PHL6}	$V_{DS}=1.0V$ $V_{IH}=V_{DD}$ $V_{IL}=GND$ $I_{OUT}=20mA$	37	45	53	ns
	GCLK↑- OUTBO , OUTA1 , OUTB2 ↑	t _{PLH3}		22	30	38	ns
Propagation Delay Time	GCLK↑– OUTC1 , OUTA3 , OUTC3 ↑	t _{PLH4}	R_L =150 Ω	27	35	43	ns
("L" to "H")	GCLK↑- OUTAO , OUTCO , OUTA2 ↑	t _{PLH5}	C _L =10pF C1=4.7uF	32	40	48	ns
	GCLK↑– OUTB1, OUTC2, OUTB3↑	t _{PLH6}	C2=0.1uF	37	45	53	ns
Pulse Width	CKI*	t _{w(I)}	C3=4.7uF C _{CKO} =8pF	15	1	ı	ns
Minimum Pulse Width of PWM	OUTAn~ OUTCn	t _{WDM}	C _{SDO} =8pF	38	-	-	ns
Rise Time	CKO/SDO	t _{OR}		2.0	3.5	5.0	ns
Nise Time	OUTAn~OUTCn	t _{OR1}		8.0	12.0	15.0	ns
Fall Time	CKO/SDO	t _{OF}		2.0	3.5	5.0	ns
i ali Tillie	OUTAn~OUTCn	t _{OF1}		12.0	16.0	20.0	ns
Fragueney	CKI*	F _{CKI}		0.2	-	10	MHz
Frequency	Internal Oscillator	Fosc		24	26	28	IVIITIZ

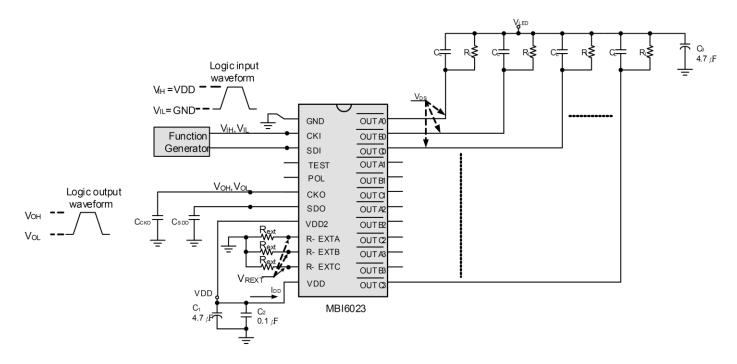
^{*}The maximum frequency may be limited by different application conditions. Please refer to the application note for details.

Switching Characteristics (V_{pp} =3.3V, Ta=25°C)

	Characteristics	Symbol	Condition	Min.	Тур.	Max.	Unit
Setup Time	SDI-CKI↓	t _{SU}		7.5	-	-	ns
Hold Time	CKI↓-SDI	t _{HD}		7.5	-	-	ns
	CKI↑–CKO↓	t _{PHL1}		-	75	-	ns
	CKI↓-SDO↑↓	t _{PHL2}		-	67	-	ns
Propagation	GCLK↑- OUTBO , OUTA1 , OUTB2 ↓	t _{PHL3}		32	40	48	ns
Delay Time ("H" to "L")	GCLK↑- OUTC1, OUTA3, OUTC3↓	t _{PHL4}	., .,	40	48	56	ns
	GCLK↑- OUTAO , OUTCO , OUTA2 ↓	t _{PHL5}	V_{LED} =4V V_{DS} =1.0V	48	56	64	ns
	GCLK↑– OUTB1 , OUTC2 , OUTB3 ↓	t _{PHL6}	$V_{IH}=V_{DD}$	56	64	72	ns
	GCLK↑- OUTB0 , OUTA1 , OUTB2 ↑	t _{PLH3}	V _{IL} =GND I _{OUT} =20m	32	40	48	ns
Propagation Delay Time	GCLK↑– OUTC1 , OUTA3 , OUTC3 ↑	t _{PLH4}	A R _ι =150Ω	40	48	56	ns
("L" to "H")	GCLK↑- OUTAO , OUTCO , OUTA2 ↑	t _{PLH5}	$C_L=10pF$	48	56	64	ns
	GCLK↑– OUTB1, OUTC2, OUTB3↑	t _{PLH6}	C1=4.7uF C2=0.1uF	56	64	72	ns
Pulse Width	CKI*	t _{w(I)}	C3=4.7uF	20	-	-	ns
Minimum Pulse Width of PWM	OUTAn~ OUTCn	t _{WDM}	C_{CKO} =8pF C_{SDO} =8pF	38	-	-	ns
Rise Time	CKO/SDO	t _{OR}		3.0	6.0	9.0	ns
Rise Tillle	OUTAn~OUTCn	t _{OR1}		12.0	18.0	24.0	ns
Fall Time	CKO/SDO	t _{OF}		3.0	6.0	9.0	ns
i all tillie	OUTAn~OUTCn	t _{OF1}		30.0	35.0	40.0	ns
Fraguenay	CKI*	F _{CKI}		0.2	-	10	MHz
Frequency	Internal Oscillator	Fosc		24	26	28	IVIITZ

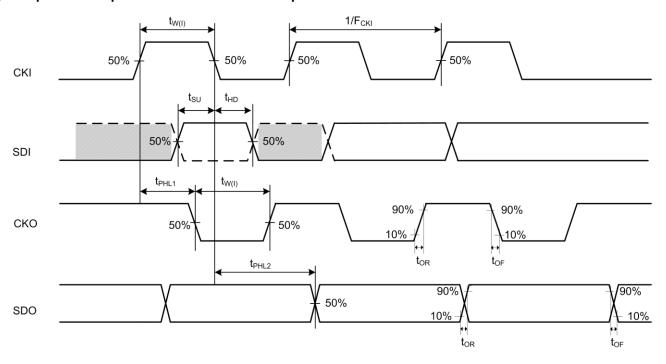
^{*}The maximum frequency may be limited by different application conditions. Please refer to the application note for details.

Test Circuit for Electrical / Switching Characteristics

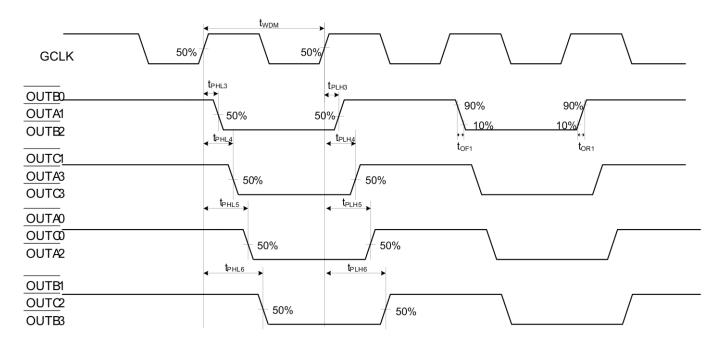


Timing Waveform

Signal Input and Output with Phase-inversed Output Clock



Output Timing



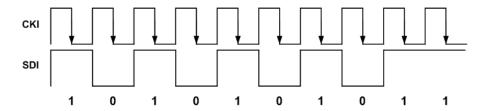
Principle of Operation

MBI6023 provides SPI-like interface (CKI, SDI), a two-wire transmission interface, to address the data, so that MBI6023 receives the data directly without a latch command.

MBI6023 receives the data packet containing targeted gray scale (GS) data from the controller, and turns on the output channels according to the gray scale data. The gray scale clock of PWM generator, GCLK, is generated by the embedded oscillator.

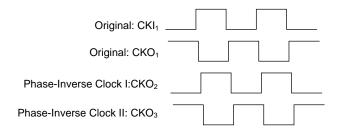
Control Interface: SPI-Like Interface (CKI, SDI)

MBI6023 adopts the SPI-like interface (CKI/SDI). By SPI-like interface, MBI6023 samples the data (SDI) at the falling edge of the clock (CKI). The following waveforms is the example of the SPI-like interface.



Phase-inversed Output Clock

MBI6023 enhances the capability of cascading MBI6023 by phase-inversed output clock function. By phase-inversed output clock, the clock phase will be inversed from CKI to CKO to eliminate the accumulation of the pulse width deviation. This improves the signal integrity of data transmission. The following chart illustrates the phase-inversed output clock results.



The Structure of Data Packet

MBI6023's data packet contains three parts:

1. Prefix:

The prefix is a symbol of "Silent-to-Reset", i.e. a time period for MBI6023 to distinguish two data packets. During the prefix, both CKI and SDI should be tied-low and stop for more than 172 CKI cycles.

2. Header:

The header defines the cascaded IC numbers and also contains a command to decide the data type.

3. Data:

These are the gray scale data for each IC.

Structure of a data packet:

Prefix	Header	Data

Setting the Data Types by the Command

MBI6023 provides two kinds of commands and input data types shown as the table below:

Command H[5:0]	Data Type
6'b11 1111	16-bit gray scale data
6'b10 1011	10-bit gray scale data

Once MBI6023 receives the SDI=1 (1'b1), MBI6023 will start to check if the data is a valid command or not. If the 6-bit data is a valid command, the driver will latch the specific data according to the protocol. If the 6-bit data is not a valid command, MBI6023 will wait for another SDI=1 (1'b1) to check the validity of the next command.

When enable function of polarity reversion, by connecting pin POL to GND, MBI6023 would only accept 10-bit grayscale command listed below

Command H[5:0]	Data Type
6'b10 1011	10-bit gray scale data

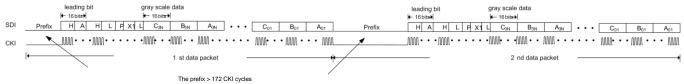
Time-Out Reset for Transmission Abort

Time-out reset is to prevent ICs from misreading during the data transmission. If the CKI is tied-low for more than 2 CKI cycles, MBI6023 may identify the wires as disconnection. To prevent from misreading, MBI6023 will ignore the present input data and continuously show the previous image data until the next image data is correctly recognized.

The Prefix in the Beginning of a Data Packet

MBI6023 identifies the data as a new data packet after time-out, so the prefix in the beginning of a data packet must be more than 172 CKI cycles.

If both CKI and SDI are tied-low and stop for more than 172 CKI cycles, MBI6023 will start to check the valid command of the next data packet. The prefix between two data packets helps MBI6023 identify the data packet correctly. The following timing diagram illustrates the interval between two data packets in gray scale mode.



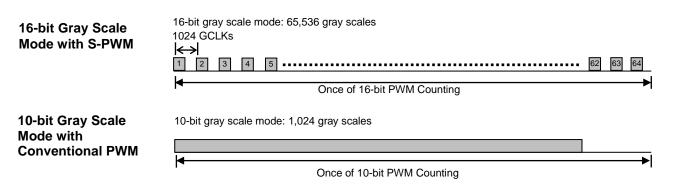
Gray Scale

MBI6023 provides two gray scale modes: 16-bit gray scale mode and 10-bit gray scale mode by adopting S-PWM or conventional PWM algorithm respectively. MBI6023 adopts S-PWM technology in 16-bit gray scale mode to scramble the 16-bit PWM to 64 segments, so that the visual refresh rate can be increased. For example, with S-PWM, the default PWM clock (GCLK) frequency is around 12MHz (the frequency of internal oscillator divided by two), and therefore, the visual refresh rate of 16-bit gray scale mode will be increased to: 12MHz/65536x64=11,718Hz

On the other hand, MBI6023 provides 10-bit gray scale mode by conventional PWM. In 16-bit gray scale mode, MBI6023 achieves 65,536 gray scales for each LED, and in 10-bit gray scale mode, MBI6023 achieves 1,024 gray scales. The following illustrations explain the PWM counting by S-PWM and conventional PWM algorithms.

PWM counting by S-PWM or conventional PWM algorithm

With S-PWM technology, the total PWM cycles can be broken down into 64 segments.



Example of 16-bit Gray Scale Data:

Gray scale data	The ratio of output turn-on time in a PWM cycle
0	0/2 ¹⁶
1	1/2 ¹⁶
2	2/2 ¹⁶
-	•
•	•
65535	65535/2 ¹⁶

Example of 10-bit Gray Scale Data:

Gray scale data	The ratio of output turn-on time in a PWM cycle
0	0/2 ¹⁰
1	1/2 ¹⁰
2	2/2 ¹⁰
•	
	•
1023	1023/2 ¹⁰

16-bit Gray Scale Data

For 16-bit gray scale data, each word is 16 bits. Each MBI6023 needs 12 words (12x16=192 bits) for the gray scale data of each output channel of one MBI6023. Prior to the gray scale data, there is a 48-bit header. MBI6023 provides parity check function to check the count of bit to prevent the transmission error. The data format is shown below:



Prefix

Both CKI and SDI should be tied-low and stop for more than 172 CKI cycles.

48-bit header

Bit	Definition	Value	Function
47:42	H[5:0]	111111	The command of 16-bit gray scale data
41:32	A[9:0]	000000000	Address data. Always send 10'b 0000000000
31:26	H[5:0]	111111	Double check the command. It should be the same as the prior H[5:0], otherwise the data packet will be ignored.
25:16	L[9:0]	N -1 N=Number of IC in series	Set the number of IC in series
			P[3:0] are parity check bits, If it is incorrect, the data packet will be ignored.
			P[0] is the parity check bit of L[9:0]
			P[0]=1 if the count of "1" within L[9:0] is odd;
			P[0]=0 if the count of "1" within L[9:0] is even.
			P[1] is the parity check bit of A[9:0]
15:12	P[3:0]		P[1]=1 if the count of "1" within A[9:0] is odd;
13.12	F [3.0]	0000~1111	P[1]=0 if the count of "1" within A[9:0] is even.
			P[2] is the parity check bit of H[5:0]
			P[2]=1 if the count of "1" within H[5:0] is odd;
			P[2]=0 if the count of "1" within H[5:0] is even.
			P[3] is the parity check bit of P[2:0]
			P[3]=1 if the count of "1" within P[2:0] is odd;
			P[3]=0 if the count of "1" within P[2:0] is even.
11:10	X1[1:0]	XX	Don't care. The value is suggested to be "0".
0.0	L[9:0]	N-1	Double shook the number of IC in parise
9:0	[ə.0]	N=Number of IC in series	Double check the number of IC in series

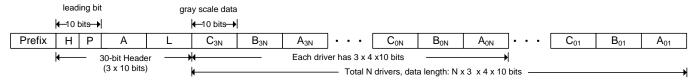
192-bit gray scale data

132-01		gray scale data		
	Bit	Definition	Value	Function
191:0 C _{3N} [15:0]~A _{0N} [15:0]	192b'0~192b'1	16-bit x 12 channels gray scale data of the Nth		
				MBI6023. The data of OUTC _{3N} is sent first.

The gray scale data of the last IC is sent first, followed by the previous ICs, and the first IC's gray scale data is sent in the end of the packet.

10-bit Gray Scale Data

For 10-bit gray scale data, each word is 10 bits. Each MBI6023 needs 12 words (12x10=120 bits) for the gray scale data of each output channel of one MBI6023. Prior to the gray scale data, there is a 30-bit header. MBI6023 provides parity check function to check the count of bit to prevent transmission error. The data format is shown below:



Prefix

Both CKI and SDI should be tied-low and stop for more than 172 CKI cycles.

30-bit header

Bit	Definition	Value	Function	
29:24	H[5:0]	101011	The command of 10-bit gray scale data	
) P[3:0]	0000~1111	P[3:0] are parity check bits, If it is incorrect, the data packet will be ignored.	
			P[0] is the parity check bit of L[9:0].	
			P[0]=1 if the count of "1" within L[9:0] is odd;	
			P[0]=0 if the count of "1" within L[9:0] is even.	
			P[1] is the parity check bit of A[9:0]	
23:20			P[1]=1 if the count of "1" within A[9:0] is odd;	
20.20			P[1]=0 if the count of "1" within A[9:0] is even.	
			P[2] is the parity check bit of H[5:0]	
			P[2]=1 if the count of "1" within H[5:0] is odd;	
			P[2]=0 if the count of "1" within H[5:0] is even.	
			P[3] is the parity check bit of P[2:0]	
			P[3]=1 if the count of "1" within P[2:0] is odd;	
			P[3]=0 if the count of "1" within P[2:0] is even.	
19:10	A[9:0]	000000000	Address data. Always send 10'b 0000000000	
9:0	L[9:0]	N-1 N=Number of IC in series	Set the number of IC in series	

120-bit gray scale data

20 bit gitty oddio data				
Bit	Definition	Value	ue Function	
119:0	C _{3N} [9:0]~A _{0N} [9:0]	120b'0~120b'1	10-bit x 12 channels gray scale data of the Nth MBI6023. The data of $\overline{\text{OUTC}_{3N}}$ is sent first.	

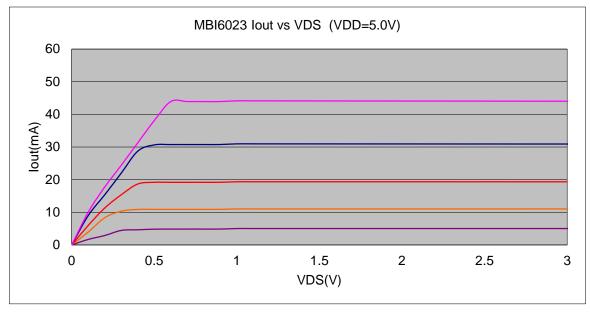
The gray scale data of the last IC is sent first, followed by the previous ICs, and the first IC's gray scale data is sent in the end of the packet.

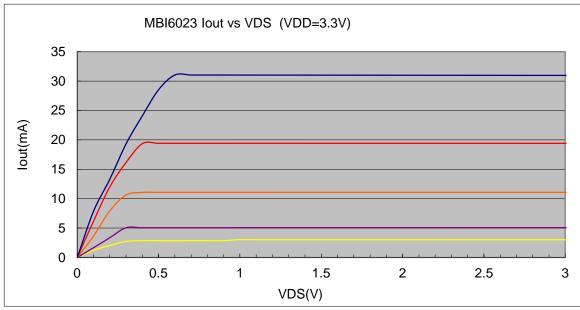
Polarity reversion

Connecting pin "POL" to GND will enable function of polarity reversion. It will set frequency of internal oscillator to 1.5Mhz and PWM counter to 10-bit mode. Please find more information about it from application note of MBI6023.

Constant Current

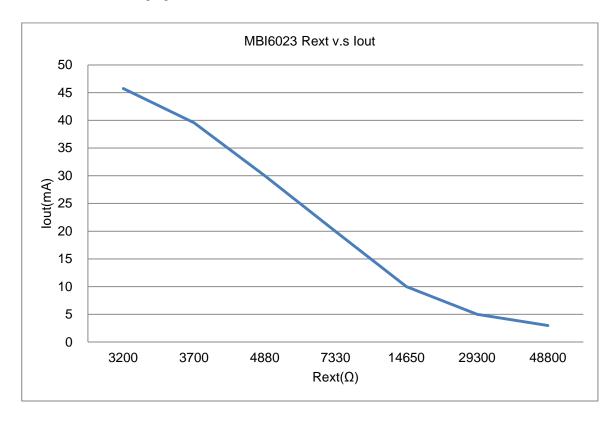
- 1) MBI6023 performs excellent current skew: the maximum current variation between channels is less than $\pm 3\%$, and that between ICs is less than $\pm 6\%$.
- 2) In addition, in the saturation region, the output current keeps constant when the output voltage (V_{DS}) is changed. This characteristic guarantees the LED show the same brightness regardless of the variations of LED forward voltages (V_F).





Setting the Output Current

The output current of each channel (I_{OUT}) is set by an external resistor, R_{ext} . The relationship between I_{OUT} and R_{ext} is shown in the following figure.



The output current of each channel (I_{OUT}) is set by an external resistor, R_{ext} . When output channels are turned on, V_{REXT} is around 1.22V. The relationship between I_{OUT} and R_{ext} is shown in the following figure.

Also, the output current can be calculated from the equation:

 $I_{OUTA} = (V_{REXT}/R_{extA})x120$

 $I_{OUTB} = (V_{REXT}/R_{extB})x120$

 $I_{OUTC} = (V_{REXT}/R_{extC})x120$

Where R_{extA} , R_{extB} , and R_{extC} are the resistances of the external resistors connected to R-EXTA, R-EXTB, R-EXTC terminals.

Package Heat Dissipation (PD)

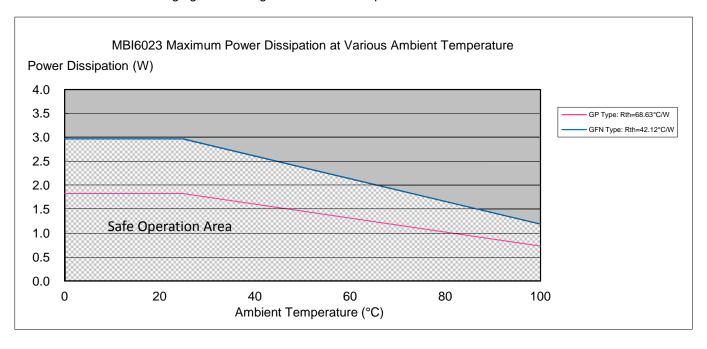
The maximum heat dissipation, $P_{D(max)} = (T_{j,max} - T_a)/R_{th(j-a)}$, decreases as the ambient temperature increases.

The heat dissipation (P_D) of MBI6023 is calculated by the equation:

$$P_{D}=(V_{DD} \times I_{DD}) + \sum_{i=0}^{i=3} (I_{OUTAi} \times V_{DSAi} \times Duty_{Ai} + I_{OUTBi} \times V_{DSBi} \times Duty_{Bi} + I_{OUTCi} \times V_{DSCi} \times Duty_{Ci})$$

For the calculation of duty cycles, please refer to the "Gray Scale" section.

Please refer to the following figure to design within the safe operation area.



Load Supply Voltage (V_{LED})

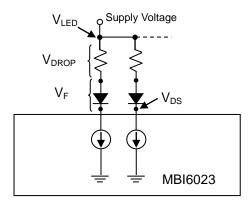
The design of V_{LED} should fulfill two targets:

- 1. Less power consumption and heat
- 2. Sufficiently headroom for the LED and driver IC to operate in the constant-current region.

From the figure below, $V_{DS}=V_{LED}-V_F$, which V_{LED} is the supply voltage of LED. $P_{D (act)}$ will be greater than $P_{D (max)}$, if V_{DS} drops too much voltage on the driver. In this case, it is recommended to use the lowest possible supply voltage or to set an external resistor to reduce the by V_{DROP} .

 $V_{DS}=(V_{LED}-V_F)-V_{DROP}$

Please refer to the following figure for the application of the resister.

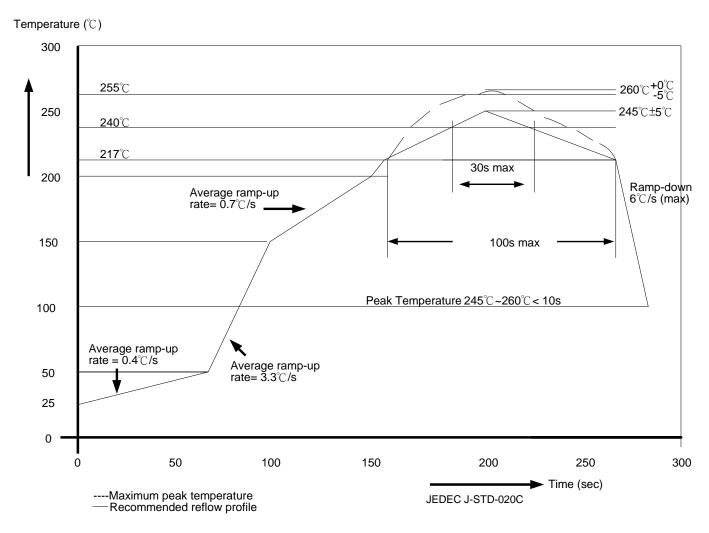


Switching Noise Reduction

The output ports of LED drivers are frequently switching in typical applications. This behavior usually causes switching noise due to the parasitic inductance on PCB. To eliminate switching noise, please refer to "Application Note for 8-bit and 16-bit LED Drivers-Overshoot".

Soldering Process of "Pb-freeb& Green" Package Plating*

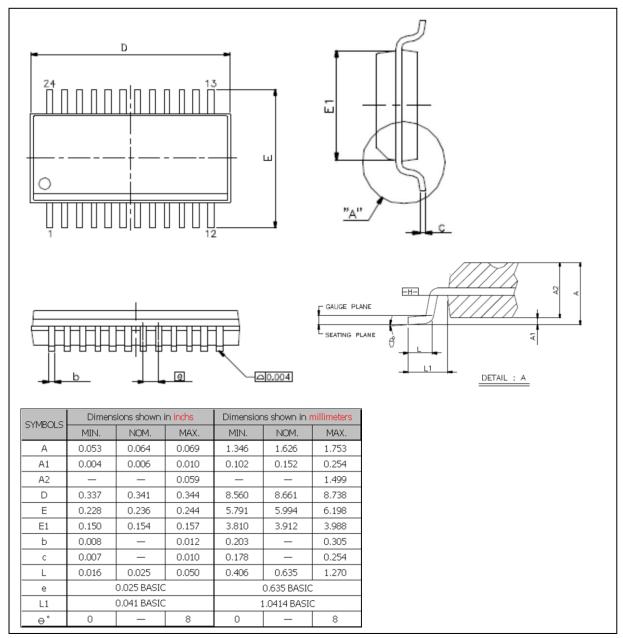
Macroblock has defined "Pb-Free & Green" to mean semiconductor products that are compatible with the current RoHS requirements and selected 100% pure tin (Sn) to provide forward and backward compatibility with both the current industry-standard SnPb-based soldering processes and higher-temperature Pb-free processes. Pure tin is widely accepted by customers and suppliers of electronic devices in Europe, Asia and the US as the lead-free surface finish of choice to replace tin-lead. Also, it is backward compatible to reflow processes which adopt tin/lead (SnPb) solder paste. Please refer to JEDEC J-STD-020C for temperature setting. However, in the whole Pb-free soldering processes and materials, 100% pure tin (Sn) will all require from 245 °C to 260 °C for proper soldering on boards, referring to JEDEC J-STD-020C as shown below.



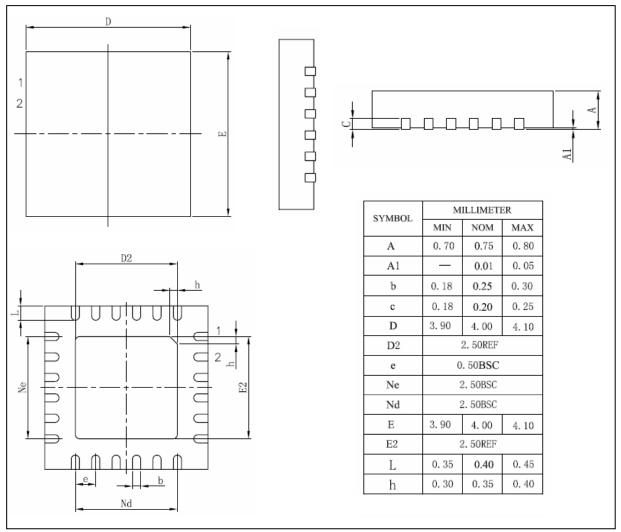
Package Thickness	Volume mm³ <350	Volume mm ³ 350-2000	Volume mm ³ ≧2000
<1.6mm	260 +0 °C	260 +0 °C	260 +0 °C
1.6mm – 2.5mm	260 +0 °C	250 +0 °C	245 +0 °C
≧2.5mm	250 +0 °C	245 +0 °C	245 +0 °C

^{*} For details, please refer to Macroblock's "Policy on Pb-free & Green Package".

Package Outline



MBI6023GP Outline Drawing

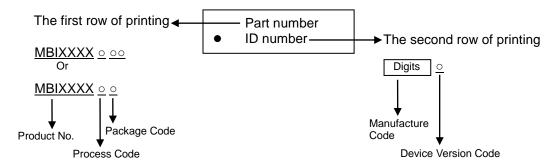


MBI6023GFN Outline Drawing

Note 1: The unit for the outline drawing is mm.

Note 2: Please use the maximum dimensions for the thermal pad layout. To avoid the short circuit risk, the vias or circuit traces shall not pass through the maximum area of thermal pad.

Product Top Mark Information



Product Revision History

Datasheet version	Device version code
V1.00	A
VA.00	Α
VB.00	В
VB.01	В

Product Ordering Information

Part Number	RoHS-Compliant Package Type	Weight (g)
MBI6023GP-B	SSOP24L-150-0.64	0.11
MBI6023GFN-B	QFN24L-4*4-0.5	0.0379

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